	O Description				Present concession	Concession first incorporated in a	Attach.	Attach.	Attach
<u>HS96</u>	Description	Base rate	Bound rate	<u>Implementation</u>		GATT Schedule Earlier INRsODC		2	<u>B</u>
3818 00	Chemical elements doped for use in electronics, in the form of discs, wafers or similar forms; chemical compounds doped for use in electronics				WT/Let	0.0			
3818 00 10	- Doped silicon	6.9	0.0	2000	WT/Let	0.0	1		
3818 00 90	- Other	6.9	0.0	2000	WT/Let	0.0	1		
7020 00	Other articles of glass				WT/Let	0.0			
7020 00 05	- Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	4	0.0	2000	WT/Let	0.0		113	
7020 00 10	- Of fused quartz or other fused silica				WT/Let	0.0			
7020 00 30	- Of glass having a linear coefficient of expansion not exceeding 5 x 10-6 per Kelvin within a temperature range of 0 °C to 300 °C				WT/Let	0.0			
7020 00 80	- Other				WT/Let	0.0			
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilizing, pasteurizing, steaming, drying, evaporating, vapourizing, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric:				WT/Let	0.0			
8419 89	Other				WT/Let	0.0			
8419 89 10	Cooling towers and similar plant for direct cooling (without a separating wall) by means of recirculated water				WT/Let	0.0			
8419 89 15	Apparatus for rapid heating of semiconductor wafers	0.0	0.0	1997	WT/Let	0.0		162	
8419 89 20	Apparatus for chemical vapour deposition on semiconductor wafers	0.0	0.0	1997	WT/Let	0.0		114	
8419 89 25	Apparatus for physical vapour deposition by electronic beam or evaporation on semiconductor wafers	0.0	0.0	1997	WT/Let	0.0		141	
8419 89 30	Vacuum-vapour plant for the deposition of metal				WT/Let	0.0			
8419 89 95					WT/Let	0.0			

<u>HS96</u>	Description	Rase rate	Bound rate	Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule Earli	ar INPaODCa		Attach. A-A-Sect.	
11090	<u>Description</u>	<u>Dase rate</u>	Dound rate	<u>Implementation</u>	<u> Lestablished</u> <u>IIVIX</u>	GATT Scriedule Lam	er iiviks odds	<u> 3601. 1</u>	∠	<u>B</u>
8419 90	- Parts				WT/Let		0.0			
8419 90 10	Of heat exchange units, for use in civil aircraft				WT/Let		0.0			
8419 90 20	Of subheading 8419 20 00				WT/Let		0.0			
8419 90 30	For apparatus of subheading 8419 89 15 to 841989 25	2.7	0.0	2000	WT/Let		0.0		115,15 8,164	
8419 90 80	Other				WT/Let		0.0			
8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases:	;			WT/Let					

					<u>Present</u>	Concession first		Attach.	
<u>HS96</u>	Description	Base rate	Bound rate	Implementation	concession established INR	incorporated in a GATT Schedule Earlier INRsO		A-Sect. <u>/</u> 2	<u>Attach</u> <u>3</u>
	- Parts			-	WT/Let		0.0		
	Of apparatus of subheading 8424 89 20	2.8	0.0	2000	WT/Let		0.0	120	
8424 90 90	Other				WT/Let	0	0.0		
8428	Other lifting, handling, loading or unloading machinery (for example, lifts, escalators, conveyors, teleferics):				WT/Let	0	0.0		
8428 39	Other				WT/Let	0	0.0		
8428 39 10	For use in civil aircraft				WT/Let	0	0.0		
	Other				WT/Let	0	0.0		
8428 39 91	Roller conveyors				WT/Let	0	0.0		
8428 39 93	Automated material handling machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.0	0.0	1997	WT/Let	0	0.0	139	
8428 39 98	Other				WT/Let	0	0.0		
8431	Parts suitable for use solely or principally with the machinery of heading Nos 8425 to 8430 :				WT/Let	0	0.0		
8431 39	Other				WT/Let	0	0.0		
8431 39 10	Of rolling-mill machinery of subheading 8428 90 30				WT/Let	0	0.0		
8431 39 20	Of machinery of subheading 8428 39 93	1.6	0.0	1999	WT/Let	0	0.0	154	
8431 39 80	Other				WT/Let	0	0.0		
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes:				WT/Let	0	0.0		
8456 10	- Operated by laser or other light or photon beam processes				WT/Let	0	0.0		

<u>HS96</u>	<u>Description</u>	Base rate Bound rate Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule		Attach. A-A-Sect. 2	
8456 99 90	Other		WT/Let		0.0		
	Machine-tools (including presses) for working metal by forging, hammering or die-stamping; machine-tools (including presses) for working metal by bending, folding, straightening, flattening, shearing, punching or notching; presses for working metal or metal carbides, not specified above:		WT/Let		0.0		

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HS96 Description Base rate Bound rate Implementation established INR GATT Schedule Earlier INRSODCS Sect. 1 2 B

8470 10 90 -- Pocket-size data recording,

					Present .	Concession first		Attach.	
HS96	Description	Base rate	Bound rate	<u>Implementation</u>	concession established INR	incorporated in a  GATT Schedule Earlier INRsODCs		A-A-Sect. 2	<u>Attacn</u> <u>B</u>
8471 60	- Input or output units, whether or not containing storage units in the same housing				WT/Let	0.0		_	
8471 60 10	) For use in civil aircraft	0.0	0.0	1997	WT/Let	0.0	15		
	Other				WT/Let	0.0			
8471 60 40	Printers	2	0.0	1999	WT/Let	0.0	15		
8471 60 50	Keyboards	2	0.0	1999	WT/Let	0.0	15		
8471 60 90	Other	2	0.0	1999	WT/Let	0.0	15		194,195
8471 70	- Storage units				WT/Let	0.0			
	For use in civil aircraft	0.0	0.0	1997	WT/Let	0.0	16		
	Other				WT/Let	0.0			
8471 70 40	Central storage units	2	0.0	1999	WT/Let	0.0	16		
	Other				WT/Let	0.0			
	Disk storage units				WT/Let	0.0			
8471 70 51	Optical, including magneto- optical	2	0.0	1999	WT/Let	0.0	16		196,201
	Other				WT/Let	0.0			
8471 70 53	3 Hard disk drives	1.6	0.0	1999	WT/Let	0.0	16		201,
8471 70 59	) Other	2	0.0	1999	WT/Let	0.0	16		201,
8471 70 60	Magnetic tape storage units	2	0.0	1999	WT/Let	0.0	16		201,
8471 70 90	Other	2	0.0	1999	WT/Let	0.0	16		201,
8471 80	- Other units of automatic data- processing machines				WT/Let	0.0			
8471 80 10	Peripheral units	2	0.0	1999	WT/Let	0.0	17		
8471 80 90	Other	2	0.0	1999	WT/Let	0.0	17		198,
8471 90 00	) - Other	2	0.0	1999	WT/Let	0.0	18		
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin- counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines):				WT/Let	0.0			
8472 90	- Other				WT/Let	0.0			
8472 90 10	Coin-sorting, coin-counting or coin-wrapping machines				WT/Let	0.0			
8472 90 30	Automatic teller machines	3.1	0.0	2000	WT/Let	0.0	19		
8472 90 80	Other				WT/Let	0.0			
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of heading Nos 8469 to 8472:								

HS96	Description	Base rate	Bound rate	<u>e Implementation</u>	Present concession established INR	Concession first incorporated in a GATT Schedule Earlier INRs OD		Attach. A-A-Sect 2	_ . <u>Attach</u> B
	Printed circuit assemblies for products of subheading No 8469 11	3.4	0.0	2000	WT/Let	0.0			199,
8473 10 19	9 Other				WT/Let	0.0			
8473 21	Of the electronic calculating machines of subheading 8470 10, 8470 21 or 8470 29				WT/Let	0.0			
8473 21 10	) Electronic assemblies	4.3	0.0	2000	WT/Let	0.0	20		199,
8473 21 90	) Other	2.5	0.0	1999	WT/Let	0.0	20		
8473 29	Other				WT/Let	0.0			
8473 29 10	) Electronic assemblies	3.4	0.0	2000	WT/Let	0.0	21		199,
8473 29 90	) Other	1.6	0.0	1999	WT/Let	0.0	21		
8473 30	- Parts and accessories of the machines of heading No 8471				WT/Let	0.0			
8473 30 10	) Electronic assemblies	3.3	0.0	2000	WT/Let	0.0	22		199,193
8473 30 90	O Other	1.6	0.0	1999	WT/Let	0.0	22		193,
8473 40	- Parts and accessories of the machines of heading No 8472				WT/Let	0.0			
8473 40 1	1 Printed circuit assemblies for products of subheading 8472 90 30	3.4	0.0	2000	WT/Let	0.0			199,
8473 40 19	9 Other				WT/Let	0.0			
8473 50	- Parts and accessories equally suitable for use with machines of two or more of the headings Nos 8469 to 8472				WT/Let	0.0			

8473 50 10

					concession	incorporated in a	Attach	A-A-Sect	<u>.</u> . Attach
HS96	<u>Description</u>	Base rate	Bound rat	<u>e Implementatior</u>		GATT Schedule Earlier INRs ODCs		<u>2</u>	<u>B</u>
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this chapter:				WT/Let	0.0			
8479 89	Other				WT/Let	0.0			
8479 89 1	0 The following goods, for use in civil aircraf: Hydropneumatic batteries; Mechanical actuators for thrust reversers; Toilet units specially designed; Air humidifiers and dehumidifiers; Servomechanisms, non-electric; Nonelectric starter motors; Pneumatic starters for turbo-jets, turbo-jets, turbo-propellers and other gas turbines; Windscreen wipers, nonelectric; Propeller regulators, nonelectric				WT/Let	0.0			
	Other				WT/Let	0.0			
8479 89 3	60 Mobile hydraulic powered mine roof supports				WT/Let	0.0			
8479 89 6	60 Central greasing systems				WT/Let	0.0			
8479 89 6	5 Apparatus for growing or pulling monocrystal semiconductor boules	0.0	0.0	1997	WT/Let	0.0		140	
8479 89 7	<ul><li>70 Apparatus for epitaxial deposition on semiconductor wafers</li></ul>	0.0	0.0	1997	WT/Let	0.0		145	
8479 89 7	75 Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let	0.0		142,16 8	
8479 89 7	6 Apparatus for wet etching, developing, stripping or cleaning liquid crystal display substrates	2.8	0.0	2000	WT/Let	0.0		142,16 8	
8479 89 7	7 Die attach apparatus and tape automated bonders for the assembly of semiconductors	2.8	0.0	2000	WT/Let	0.0		143	
8479 89 7	<ul> <li>'9 Encapsulation equipment for assembly of semiconductors</li> </ul>	2.8	0.0	2000	WT/Let	0.0		144	
8479 89 9	5 Other				WT/Let	0.0			
8479 90	- Parts				WT/Let	0.0			
8479 90 1	0 For use in civil aircraft				WT/Let	0.0			
	Other				WT/Let	0.0			
8479 90 5	50 Of machines of subheadings 8479 89 65, 8479 89 70, 8479 89 75, 8479 89 76, 8479 89 77 or 8479 89 79	2.8	0.0	2000	WT/Let	0.0		152,15 6,153,1 50,155 169	
8479 90 9	2 Of cast iron or cast steel				WT/Let	0.0			
8479 90 9	8 Other				WT/Let	0.0			

<u>Present</u>

Concession first

Attach.

					Present .	Concession first	A., 1	Attach.	
HS96	Description	Base rate	Bound rate	Implementation	concession established INR	incorporated in a GATT Schedule Earlier INRsOD	Attach. <i>I</i> Cs. Sect. 1	A-A-Sect. 2	<u>Attach</u> <u>B</u>
8480	Moulding boxes for metal foundry; mould bases; moulding patterns; moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics:				WT/Let	0.0		-	<del></del>
	- Moulds for rubber or plastics				WT/Let	0.0	)		
8480 71	Injection or compression types				WT/Let	0.0	)		
8480 71 10	of a kind used in the manufacturing of semiconductor devices	2.5	0.0	2000	WT/Let	0.0	)	159	
8480 71 90	Other				WT/Let	0.0	)		
8504	Electrical transformers, static converters (for example, rectifiers) and inductors :				WT/Let	0.0	)		
8504 40	- Static converters				WT/Let	0.0	)		
8504 40 10	For use in civil aircraft				WT/Let	0.0	)		
	Other				WT/Let	0.0	)		
	Of a kind used with telecommunication apparatus and automatic data-processing machines and units thereof :				WT/Let	0.0	)		
8504 40 30	Power supply units of a kind used with automatic data-processing machines	2	0.0	1999	WT/Let	0.0	) 24		
8504 40 35	Other	4.6	0.0	2000	WT/Let	0.0	24		
	Other				WT/Let	0.0	)		
8504 40 50	Polycrystalline semiconductors				WT/Let	0.0	)		
	Other				WT/Let	0.0	)		
8504 40 93	Accumulator chargers				WT/Let	0.0	)		
	Other				WT/Let	0.0	)		
8504 40 94	Rectifiers				WT/Let	0.0	)		
	Inverters				WT/Let	0.0	)		
8504 40 96	Having a power handling capacity not exceeding 7,5 kVA				WT/Let	0.0	)		
8504 40 97	Having a power handling capacity exceeding 7,5 kVA				WT/Let	0.0	)		
8504 40 99	Other				WT/Let	0.0	)		
8504 50	- Other inductors				WT/Let	0.0	)		
8504 50 10	For use in civil aircraft				WT/Let	0.0	)		
	Other				WT/Let	0.0	)		
8504 50 30	Of a kind used for								

					Present concession	Concession first incorporated in a		Attach A	Attach.	Attach
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>			Earlier INRsODCs	Sect. 1	<u>2</u>	<u>B</u>
	Of transformers and inductors				WT/Let		0.0			
8504 90 05	Printed circuit assemblies for products of subheading 8504 50 30	3.1	0.0	2000	WT/Let		0.0			199,
	Other				WT/Let		0.0			
8504 90 11	Ferrite cores				WT/Let		0.0			
8505 90 18	Other				WT/Let		0.0			
	Of static converters				WT/Let		0.0			
8504 90 91	Printed circuits assemblies for products of subheadings 8504 40 30 and 8504 40 35	3.1	0.0	2000	WT/Let		0.0			199,
8504 90 99	Other				WT/Let		0.0			
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment:				WT/Let		0.0			
8514 10	- Resistance heated furnaces and ovens				WT/Let		0.0			
8514 10 05	For the manufacture of semiconductor devices on semiconductor wafers	3	0.0	2000	WT/Let		0.0		160	
	Other				WT/Let		0.0			
8514 10 10	Bakery and biscuit ovens				WT/Let		0.0			
8514 10 90	Other				WT/Let		0.0			
8514 20	- Induction or dielectric furnaces and ovens				WT/Let		0.0			
8514 20 05	For the manufacture of semiconductor devices on semiconductor wafers	3	0.0	2000	WT/Let		0.0		161	
	Other				WT/Let		0.0			
8514 20 10	Induction furnaces and ovens				WT/Let		0.0			
8514 20 90	Dielectric furnaces and ovens				WT/Let		0.0			
8514 30	<ul> <li>Other furnaces and ovens</li> </ul>				WT/Let		0.0			
	<ul> <li>Infra-red radiation ovens</li> </ul>				WT/Let		0.0			
8514 30 11	For the manufacture of semiconductor devices on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		160	
8514 30 19	Other				WT/Let		0.0			
	Other				WT/Let		0.0			
8514 30 91	For the manufacture of semiconductor devices on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		160,16 2	
8514 30 99	Other				WT/Let		0.0			
8514 90	- Parts				WT/Let		0.0			
8514 90 10	Of apparatus of subheading 8514 10 05, 8514 20 05, 8514 30 11or 8514 30 91	3	0.0	2000	WT/Let		0.0		163,16 4,165	
8514 90 90					WT/Let		0.0			

					Present concession	Concession first incorporated in a	Attach A	Attach	<u>ı.</u> t. Attach
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>e Implementation</u>				<u>2</u>	<u>B</u>
8515	Electric (including electrically heated gas), laser or other light or photon beam, ultrasonic, electron beam, magnetic pulse or plasma arc soldering, brazing or welding machines and apparatus, whether or not capable of cutting; electric machines and apparatus for hot spraying of metals or cermets				WT/Let	0.0			
	<ul> <li>Brazing or soldering machines and apparatus</li> </ul>				WT/Let	0.0			
8515 11 00	) Soldering irons and guns				WT/Let	0.0			
8515 19 00	) Other				WT/Let	0.0			
	<ul> <li>Machines and apparatus for resistance welding of metal</li> </ul>				WT/Let	0.0			
8515 21 00	Fully or partly automatic				WT/Let	0.0			
8515 29	Other				WT/Let	0.0			
8515 29 10	For butt welding				WT/Let	0.0			
8515 29 90	) Other				WT/Let	0.0			
	- Machines and apparatus for arc (including plasma arc) welding of metals				WT/Let	0.0			
8515 31 00	Fully or partly automatic				WT/Let	0.0			
8515 39	Other				WT/Let	0.0			
	For manual welding with coated electrodes, complete with welding or cutting devices, and consigned with				WT/Let	0.0			
8515 39 13	3 Transformers				WT/Let	0.0			
8515 39 18	3 Generators or rotary converters or static converters, rectifiers or rectifying apparatus				WT/Let	0.0			
8515 39 90	) Other				WT/Let	0.0			
8515 80	- Other machines and apparatus				WT/Let	0.0			
8515 80 05	5 Wire bonders of a kind used for manufacturing semiconductor devices	3.7	0.0	2000	WT/Let	0.0		143	
	Other				WT/Let	0.0			
	For treating metals				WT/Let	0.0			
8515 80 11	I For welding				WT/Let	0.0			
8515 80 19	Other				WT/Let	0.0			
	Other				WT/Let	0.0			
8515 80 91	For resistance welding of plastics				WT/Let	0.0			
8515 80 99	9 Other				WT/Let	0.0			
8515 90	- Parts				WT/Let	0.0			
8515 90 10	For machines of subheading 8515 80 05	3.7	0.0	2000	WT/Let	0.0		143	
8515 90 90					WT/Let	0.0			

<u>HS96</u>	<u>Description</u>	Base rate	Bound rat	<u>e Implementatior</u>	Present concession established INR	Concession first incorporated in a GATT Schedule	Earlier INRs ODCs		Attach. A-A-Sect. A 2 B	
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier -current line systems or for digital line systems; videophones:				WT/Let		0.0			
	- Telephone sets; videophones				WT/Let		0.0			
8517 11 00	<ul> <li>Line telephone sets with cordless handsets</li> </ul>	7.5	0.0	2000	WT/Let		0.0	26		
8517 19	Other				7an2 TD28168 re	e 11. rg 1296 54òt	ach24.hed1317 T	8 m dl0 T	W	

HS9	6 <u>Description</u>	Base rate	Bound r	ate Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule	•		Attach A-A-Sect 2	<u>ı.</u> t. <u>Attach</u> <u>B</u>
85	518 10 20 Microphones having a frequency range of 300 Hz to 3.4 KHz with a diameter not exceeding 10 mm and a height not exceeding 3 mm, for telecommunications use	3.5	0.0	2000	WT/Let		0.0	34		
85	518 10 80 Other				WT/Let		0.0			
85	518 29 Other				WT/Let		0.0			
85	518 29 10 For use in civil aircraft				WT/Let		0.0			

					Present concession	Concession first incorporated in a	Attach	Attach. A-A-Sect.	
<u>HS96</u>	<u>Description</u>	Base rate	Bound rat	<u>e Implementatior</u>		GATT Schedule Earlier INRsODC		<u>2</u>	<u>B</u>
8522 90 9	93 Single cassette-deck assemblies with a total thickness not exceeding 53 mm, of a kind used in the manufacture of sound recording and reproducing apparatus	S			WT/Let	0.0			
8522 90 9	98 Other				WT/Let	0.0			
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37:				WT/Let	0.0			
	<ul> <li>Magnetic tapes</li> </ul>				WT/Let	0.0			
8523 11 (	00 Of a width not exceeding 4 mm	3.2	0.0	2000	WT/Let	0.0	38		
8523 12 (	00 Of a width exceeding 4 mm but not exceeding 6,5 mm	4.1	0.0	2000	WT/Let	0.0	39		
8523 13 (	00 Of a width exceeding 6,5 mm	4.1	0.0	2000	WT/Let	0.0	40		
8523 20	- Magnetic discs				WT/Let	0.0			
	Rigid				WT/Let	0.0			
8523 20 1	11 With a thin film metallic coating, having a coercivity exceeding 600 Oersted and an external diameter not exceeding 231 mm	2	0.0	1999	WT/Let	0.0	41		201,
8523 20 1	19 Other	4.1	0.0	2000	WT/Let	0.0	41		201,
8523 20 9	90 Other	4.1	0.0	2000	WT/Let	0.0	41		201,
8523 90 (	00 - Other	4.1	0.0	2000	WT/Let	0.0	42		201,
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37:				WT/Let	0.0			
	<ul> <li>Discs for laser reading systems</li> </ul>				WT/Let	0.0			
8524 31 (	00 For reproducing phenomena other than sound or image	4.1	0.0	2000	WT/Let	0.0	43		201,
8524 32 (	00 For reproducing sound only				WT/Let	0.0			
8524 39	Other				WT/Let	0.0			
8524 39 1	10 For reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine		0.0	2000	WT/Let	0.0	44		201,
8524 39 9	90 Other				WT/Let	0.0			
8524 40	<ul> <li>Magnetic tapes for reproducing phenomena other than sound or image</li> </ul>				WT/Let	0.0			
8524 40 1	<ul> <li>10 Bearing data or instructions of a kind used in automatic data- processing machines</li> </ul>	2	0.0	1999	WT/Let	0.0	45		201,

					<u>Present</u>	Concession first		Attach.	A ttoob
<u>HS96</u>	<u>Description</u>	Base rate	Bound rat	<u>e Implementatio</u>	concession established INR	GATT Schedule Earlier INRsODCs	Attach. A-A Sect. 1 2		<u> </u>
	Other				WT/Let	0.0			
8524 40 91	Of a width exceeding 4 mm but not exceeding 6,5 mm	3.6	0.0	2000	WT/Let	0.0	45	2	201,
8524 40 99	Other	4.1	0.0	2000	WT/Let	0.0	45	2	201,
	- Other				WT/Let	0.0			
8524 91	<ul> <li>For reproducing phenomena other than sound or image</li> </ul>				WT/Let	0.0			
8524 91 10	<ul> <li> Bearing data or instructions of a kind used in automatic data- processing machines</li> </ul>	2	0.0	1999	WT/Let	0.0	46	2	201,
8524 91 90	Other	4.1	0.0	2000	WT/Let	0.0	46	2	201,
8524 99	Other				WT/Let	0.0			
	For reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine		0.0	2000	WT/Let	0.0	47	2	201,
8524 99 90	Other				WT/Let	0.0			
8525	Transmission apparatus for radio- telephony, radio-telegraphy, radio- broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders:				WT/Let	0.0			
8525 10	- Transmission apparatus				WT/Let	0.0			
	<ul> <li>Radio-telegraphic or radio- telephonic apparatus:</li> </ul>				WT/Let	0.0			
	for use in civil aircraft				WT/Let	0.0			
	Radio-telegraphic or radio- telephonic apparatus	4.1	0.0	2000	WT/Let	0.0	48		
8525 10 80					WT/Let	0.0			
8525 20	- Transmission apparatus incorporating reception apparatus				WT/Let	0.0			
8525 20 10	<ul> <li> Radio-telegraphic or radio- telephonic apparatus, for use in civil aircraft</li> </ul>	0.0	0.0	1997	WT/Let	0.0	49		
	Other				WT/Let	0.0			
	For cellular networks (mobile telephones)	6.5	0.0	2000	WT/Let	0.0	49		
8525 20 99		6.5	0.0	2000	WT/Let	0.0	49	2	203,
8525 40	- Still image video cameras and other video camera recorders				WT/Let	0.0			
	Still image video cameras				WT/Let	0.0			
8525 40 11	Digital	4.9	0.0	2000	WT/Let	0.0	50		

					Present .	Concession first	A 1	Attach	
<u>HS96</u>	Description	Base rate	Bound rat	te Implementatior	<u>concession</u> L <u>established INR</u>	incorporated in a GATT Schedule Earlier INRs ODCs		<u>A-A-Sec</u>	<u>t. Attach</u> <u>B</u>
8525 40 19	Other				WT/Let	0.0			
	Other video camera recorders				WT/Let	0.0			
8525 40 91	Only able to record sound and images taken by the television camera				WT/Let	0.0			
8525 40 99	Other				WT/Let	0.0			
8527	Reception apparatus for radio- telephony, radio-telegraphy or radio- broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock:				WT/Let	0.0			
8527 90	- Other apparatus				WT/Let	0.0			
8527 90 10	For radio-telephony or radio- telegraphy, for use in civil aircraft				WT/Let	0.0			
	Other				WT/Let	0.0			
8527 90 92	Portable receivers for calling, alerting or paging	9.6	0.0	2000	WT/Let	0.0	51		197,
8527 90 98	Other				WT/Let	0.0			
8528	Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus; video monitors and video projectors:				WT/Let	0.0			
	- Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus				WT/Let	0.0			
8528 12	Colour				WT/Let	0.0			
8528 12 10	Apparatus combined with an automatic data processing machine, freely programmable by the user	14	0.0	2000	WT/Let	0.0			191,
	Other				WT/Let	0.0			
	Television projection equipment				WT/Let	0.0			
8528 12 14	With scanning parameters not exceeding 625 lines				WT/Let	0.0			
	With scanning parameters exceeding 625 lines				WT/Let	0.0			
8528 12 16	With a vertical resolution of less than 700 lines				WT/Let	0.0			
8528 12 18	With a vertical resolution of 700 lines or more				WT/Let	0.0			
	Apparatus incorporating a video recorder or reproducer				WT/Let	0.0			
8528 12 22	With a screen width/height ratio less than 1,5				WT/Let	0.0			
8528 12 28	Other				WT/Let	0.0			

<u>HS96</u>	Description	Present concession  Base rate Bound rate Implementation established I		Attach. Attach. A-A-Sect. Attach Sect. 1 2 B
	Other	WT/Let	0.0	
	With integral tube	WT/Let	0.0	
	With a screen width/height ratio less than 1,5, with a diagonal measurement of the screen	WT/Let	0.0	
8528 12 52	2 Not exceeding 42 cm	WT/Let	0.0	
8528 12 54	Exceeding 42 cm but not exceeding 52 cm	WT/Let	0.0	
8528 12 56	3			

<u>HS96</u>	Description	Base rate	Bound ra	ate Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule	-	Attach A-Sec 2	n. t. Attach B
8528 30	0.05 Of the flat panel type, capable of displaying digital information generated by the central processing unit of an automatic data processing machine		0.0	2000	WT/Let		0.0		200,
	Other				WT/Let		0.0		
8528 30	) 20 Colour				WT/Let		0.0		

<u>HS96</u>	<u>Description</u>	Base rate	Bound rate l	Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule Earlier INRs C		Attach A-A-Sect 2	_
8529 90 70	) Electronic assemblies				WT/Let	(	0.0		
	Other				WT/Let		0.0		
8529 90 81	1 For television cameras of subheading No 8525 30 and apparatus of heading Nos 8527 and 8528				WT/Let	(	0.0		
8529 90 89	9 Other				WT/Let		0.0		
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No 8512 or 8530:				WT/Let	(	0.0		
8531 20	<ul> <li>Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)</li> </ul>				WT/Let		0.0		
8531 20 10	O For use in civil aircraft	0.0	0.0	1997	WT/Let				

					Present concession	Concession first incorporated in a	Attach /	Attach. A-A-Sect. A	Attach -
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>		GATT Schedule Earlier INRs ODC	Sect. 1		<u>3</u>
8532 23 00	Ceramic dielectric, single layer	3.6	0.0	2000	WT/Let	0.0	59		
	Ceramic dielectric, multilayer				WT/Let	0.0			
8532 24 10	With connecting leads	3.6	0.0	2000	WT/Let	0.0	60		
8532 24 90	Other	3.6	0.0	2000	WT/Let	0.0	60		
8532 25 00	Dielectric of paper or plastics	3.6	0.0	2000	WT/Let	0.0	61		
8532 29 00	Other	3.6	0.0	2000	WT/Let	0.0	62		
8532 30 00	- Variable or adjustable (pre-set) capacitors	5	0.0	2000	WT/Let	0.0	63		
8532 90 00	- Parts	4.7	0.0	2000	WT/Let	0.0	64		
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors:				WT/Let	0.0			
8533 10 00	<ul> <li>Fixed carbon resistors, composition or film types</li> </ul>	3.7	0.0	2000	WT/Let	0.0	65		
	- Other fixed resistors				WT/Let	0.0			
8533 21 00	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let	0.0	66		
8533 29 00	Other	3.7	0.0	2000	WT/Let	0.0	67		
	- Wirewound variable resistors, including rheostats and potentiometers				WT/Let	0.0			
8533 31 00	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let	0.0	68		
8533 39 00	Other	3.7	0.0	2000	WT/Let	0.0	69		
8533 40	- Other variable resistors, including rheostats and potentiometers				WT/Let	0.0			
8533 40 10	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let	0.0	70		
8533 40 90	Other	3.7	0.0	2000	WT/Let	0.0	70		
8533 90 00	- Parts	3.7	0.0	2000	WT/Let	0.0	71		
8534 00	Printed circuits				WT/Let	0.0			
	- Consisting only of conductor elements and contacts				WT/Let	0.0			
8534 00 11	Multiple circuits	5.2	0.0	2000	WT/Let	0.0	72		
8534 00 19	Other	5.2	0.0	2000	WT/Let	0.0	72		
8534 00 90	- With other passive elements	5.2	0.0	2000	WT/Let	0.0	72		
8536	Electrical apparatus for switching or protecting electrical circuits, or for	•							

Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lampholders, junction boxes), for a voltage not exceeding 1 000 V:

					Present concession	Concession first incorporated in a	Attach	Attach. A-A-Sect. Attach
<u>HS96</u>	<u>Description</u>	Base rate	Bound rat	<u>e Implementatio</u>	established INR	GATT Schedule Earlier INRs ODC	Sect. 1	<u>2</u> <u>B</u>
8536 50 0	3 Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switchs)	3.2	0.0	2000	WT/Let	0.0	73	
8536 50 0	5 Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology)	3.2	0.0	2000	WT/Let	0.0	74	
8536 50 0	<ul><li>7 Electromechanical snap-acion switches for a current not exceeding 11 amps</li></ul>	3.2	0.0	2000	WT/Let	0.0	75	
	Other				WT/Let	0.0		
	For a voltage not exceeding 60 V	1			WT/Let	0.0		
8536 50 1	1 Push-button switches				WT/Let	0.0		
8536 50 1	5 Rotary switches				WT/Let	0.0		
8536 50 1	9 Other				WT/Let	0.0		
8536 50 9	0 Other				WT/Let	0.0		
8536 69	Other				WT/Let	0.0		
8536 69 1	0 For co-axial cables	3.2	0.0	2000	WT/Let	0.0	76	
8536 69 3	0 For printed circuits	3.2	0.0	2000	WT/Let	0.0	76	
8536 69 9	0 Other				WT/Let	0.0		
8536 90	- Other apparatus				WT/Let	0.0		
	Prefabricated elements for electrical circuits				WT/Let	0.0		
8536 90 1	0 Connections and contact elements for wire and cables	3.2	0.0	2000	WT/Let	0.0	77	
8536 90 2	0 Wafer probers	0.0	0.0	1997	WT/Let	0.0		166
8536 90 8	5 Other				WT/Let	0.0		
8541	Diodes, transistors and similar semiconductor devices; photosensitive semi- con- ductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes; mounted piezo-electric crystals:				WT/Let	0.0		
8541 10	<ul> <li>Diodes, other than photosensitive or light-emitting diodes</li> </ul>				WT/Let	0.0		
8541 10 1	0 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.0	78	
	Other				WT/Let	0.0		
8541 10 9	1 Power rectifier diodes	7	0.0	1999	WT/Let	0.0	78	
8541 10 9	9 Other	7	0.0	1999	WT/Let	0.0	78	
	<ul> <li>Transistors, other than photosensitive transistors</li> </ul>				WT/Let	0.0		
8541 21	With a dissipation rate of less than 1 W				WT/Let	0.0		
8541 21 1	0 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.0	79	

					Present concession	Concession first incorporated in a	Δ		ttach. -Sect. Attacl	h -
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	<u>established INR</u>	GATT Schedule Earlier INRs OI	DCs S	ect. 1 2	<u>B</u>	<u> </u>
8541 21	90 Other	7	0.0	1999	WT/Let	0.	.0 79	9		-
8541 29	Other				WT/Let	0.	.0			
8541 29	10 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.	.0 80	0		
	20 PowerMOS field effective	7	0.0	1999	WT/Let	0.	.0 80	0		
	transistors									
8541 29	30 Insulated gate bipolar transistors (IGBTs)	7	0.0	1999	WT/Let	0.	.0 80	0		
8541 29	80 Other	7	0.0	1999	WT/Let	0.	.0 80	0		
8541 30	<ul> <li>Thyristors, diacs and triacs, other than photosensitive devices</li> </ul>				WT/Let	0.	.0			
8541 30	10 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.	.0 8	1		
8541 30	90 Other	7	0.0	1999	WT/Let	0.	.0 8	1		
8541 40	devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes				WT/Let	0.	.0			
	Light-emitting diodes				WT/Let	0.	.0			
8541 40	11 Laser diodes	7	0.0	1999	WT/Let	0.	.0 82	2		
8541 40	19 Other	7	0.0	1999	WT/Let	0.	.0 82	2		
	Other				WT/Let	0.	.0			
8541 40	91 Solar cells whether or not assembled in modules or made up into panels	3.2	0.0	1999	WT/Let	0.	.0 82	2		
8541 40	93 Photodiodes, phototransistors, photothyristors or photocouples	1.8	0.0	1999	WT/Let	0.	.0 82	2		
8541 40	99 Other	1.8	0.0	1999	WT/Let	0.	.0 82	2		
8541 50	<ul> <li>Other semiconductor devices</li> </ul>				WT/Let	0.	.0			
8541 50	10 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.	.0 8	3		
8541 50	90 Other	7	0.0	1999	WT/Let	0.	.0 8	3		
8541 60	00 - Mounted piezo-electric crystals	5.6	0.0	1999	WT/Let	0.	.0 8	4		
8541 90	00 - Parts	4.1	0.0	1999	WT/Let	0.	.0 8	5		
8542	Electronic integrated circuits and microassemblies:				WT/Let	0.	.0			
	<ul> <li>Monolithic digital integrated circuits</li> </ul>				WT/Let	0.	.0			
8542 12	00 Cards incorporating an electronic integrated circuit («smart» cards)	14	0.0	1999	WT/Let	0.	.0 80	6		
8542 13	<ul> <li>Metal oxide semiconductors (MOS technology)</li> </ul>				WT/Let	0.	.0			
8542 13	01 Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.	.0 8	7		
8542 13	05 Chips	7	0.0	1999	WT/Let	0.	.0 8	7		
	Other				WT/Let	0.	.0			
	Memories				WT/Let	0.	.0			
	Dynamic random-access memories (D-RAMs)				WT/Let	0.	.0			

					Present concession	Concession first incorporated in a	Attach.	Attach. A-A-Sect.	
<u>HS96</u>	Description	Base rate	Bound rate	<u>Implementation</u>		GATT Schedule Earlier INRsOD		2	<u>B</u>
8542 13 11	With a storage capacity not exceeding 4 Mbits	7	0.0	1999	WT/Let	0.0	87		
8542 13 13	With a storage capacity exceeding 4 Mbits but not exceeding 16 Mbits	7	0.0	1999	WT/Let	0.0	87		
8542 13 15	With a storage capacity exceeding 16 Mbits but not exceeding 64 Mbits	7	0.0	1999	WT/Let	0.0	87		
8542 13 17	With a storage capacity exceeding 64 Mbits	7	0.0	1999	WT/Let	0.0	87		
	Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)				WT/Let	0.0			
8542 13 22	With a storage capacity not exceeding 256 Kbits	0.0	0.0	1997	WT/Let	0.0	87		
8542 13 25	With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	0.0	0.0	1997	WT/Let	0.0	87		
8542 13 27	With a storage capacity exceeding 1 Mbit	0.0	0.0	1997	WT/Let	0.0	87		
	UV erasable, programmable, read only memories (EPROMs)				WT/Let	0.0			
8542 13 32	With a storage capacity not exceeding 1 Mbit	0.0	0.0	1997	WT/Let	0.0	87		
8542 13 35	With a storage capacity exceeding 1 Mbit but not exceeding 4 Mbits	0.0	0.0	1997	WT/Let	0.0	87		
8542 13 37	With a storage capacity exceeding 4 Mbits	0.0	0.0	1997	WT/Let	0.0	87		
	Electrically erasable, programmable, read only memories (E²PROMs), including FLASH E²PROMs				WT/Let	0.0			
	FLASH E <sup>2</sup> PROMs				WT/Let	0.0			
8542 13 41	With a storage capacity not exceeding 1 Mbit	0.0	0.0	1997	WT/Let				

					Present concession	Concession first incorporated in a		Attach. . A-A-Sect. Attach
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	<u>n established INR</u>	GATT Schedule Earlier INRsODO	<u> Sect. 1</u>	<u> 2 B</u>
8542 13 51	Read only memories, non- programmable (ROMs); content addressable memories (CAMs); first- in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let	0.0	87	
8542 13 53	3 Other memories	7	0.0	1999	WT/Let	0.0	87	
8542 13 55	5 Microprocessors	0.0	0.0	1997	WT/Let	0.0	87	
	Microcontrollers and microcomputers				WT/Let	0.0		
8542 13 61	With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let	0.0	87	
8542 13 63	3 With a processing capacity exceeding 4 bits but not exceeding 8 bits	7	0.0	1999	WT/Let	0.0	87	
8542 13 65	5 With a processing capacity exceeding 8 bits but not exceeding 16 bits	7	0.0	1999	WT/Let	0.0	87	
8542 13 67	<ul> <li>With a processing capacity exceeding 16 bits but not exceeding 32 bits</li> </ul>	7	0.0	1999	WT/Let	0.0	87	
8542 13 69	With a processing capacity exceeding 32 bits	7	0.0	1999	WT/Let	0.0	87	
	Other				WT/Let	0.0		
8542 13 70	) Microperipherals	5.6	0.0	1999	WT/Let	0.0	87	
	Other				WT/Let	0.0		
8542 13 72	2 Full custom logic circuits	7	0.0	1999	WT/Let	0.0	87	
8542 13 74	Gate arrays	7	0.0	1999	WT/Let	0.0	87	
8542 13 76	S Standard cells	7	0.0	1999	WT/Let	0.0	87	
8542 13 82	2 Programmable logic circuits	5.6	0.0	1999	WT/Let	0.0	87	
8542 13 84	Standard logic circuits	5.6	0.0	1999	WT/Let	0.0	87	
	Other				WT/Let	0.0		
8542 13 91	Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let	0.0	87	
8542 13 99	) Other	7	0.0	1999	WT/Let	0.0	87	
8542 14	<ul> <li>Circuits obtained by bipolar technology</li> </ul>				WT/Let	0.0		
8542 14 01	Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.0	88	
8542 14 05	5 Chips	7	0.0	1999	WT/Let	0.0	88	
	Other				WT/Let			

					Present	Concession first		Attach	
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	concession Lestablished <u>INR</u>	incorporated in a  GATT Schedule Earlier INRs ODCs			t. Attach B
	Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs); read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let	0.0	88	-	
8542 14 20	Electrically erasable, programmable, read only memories (E²PROMs), including FLASH E²PROMs	0.0	0.0	1997	WT/Let	0.0	88		
8542 14 22	UV erasable, programmable, read only memories (EPROMs)	0.0	0.0	1997	WT/Let	0.0	88		
8542 14 29	Other memories	7	0.0	1999	WT/Let	0.0	88		
8542 14 30	Microprocessors	0.0	0.0	1997	WT/Let	0.0	88		
	Microcontrollers and microcomputers				WT/Let	0.0			
8542 14 42	With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let	0.0	88		
8542 14 44	With a processing capacity exceeding 4 bits	7	0.0	1999	WT/Let	0.0	88		
	Other				WT/Let	0.0			
8542 14 50	Microperipherals	5.6	0.0	1999	WT/Let	0.0	88		
	Other				WT/Let	0.0			
8542 14 60	Full custom logic circuits	7	0.0	1999	WT/Let	0.0	88		
8542 14 65	Gate arrays	7	0.0	1999	WT/Let	0.0	88		
8542 14 70	Standard cells	7	0.0	1999	WT/Let	0.0	88		
8542 14 75	Programmable logic circuits	5.6	0.0	1999	WT/Let	0.0	88		
8542 14 80	Standard logic circuits	5.6	0.0	1999	WT/Let	0.0	88		
	Other				WT/Let	0.0			
8542 14 91	Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let	0.0	88		
8542 14 99	Other	7	0.0	1999	WT/Let	0.0	88		
8542 19	Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)				WT/Let	0.0			
8542 19 01	Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.0	89		
8542 19 05	Chips	7	0.0	1999	WT/Let	0.0	89		
	Other				WT/Let	0.0			
	Memories				WT/Let	0.0			
8542 19 15	Dynamic random-access memories (D-RAMs)	7	0.0	1999	WT/Let	0.0	89		

					Present concession	Concession first incorporated in a	Attac	Atta	<u>ch.</u> ect. Attach
<u>HS96</u>	Description	Base rate	Bound rat	<u>e Implementatior</u>		GATT Schedule Earlier INRs ODG			<u>B</u>
	Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)				WT/Let	0.0			
8542 19 22	With a storage capacity not exceeding 256 Kbits	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 25	With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 27	With a storage capacity exceeding 1 Mbit	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 31	UV erasable, programmable, read only memories (EPROMs)	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 35	Electrically erasable, programmable, read only memories (E²PROMs), including FLASH E²PROMs	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 41	Read only memories, non- programmable (ROMs); content addressable memories (CAMs); first- in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let	0.0	89		
8542 19 49	Other memories	7	0.0	1999	WT/Let	0.0	89		
8542 19 55	Microprocessors	0.0	0.0	1997	WT/Let	0.0	89		
	Microcontrollers and microcomputers				WT/Let	0.0			
8542 19 62	With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let	0.0	89		
8542 19 68	With a processing capacity exceeding 4 bits	7	0.0	1999	WT/Let	0.0	89		
	Other				WT/Let	0.0			
8542 19 71	Microperipherals	5.6	0.0	1999	WT/Let	0.0	89		
	Other				WT/Let	0.0			
8542 19 72	Full custom logic circuits	7	0.0	1999	WT/Let	0.0	89		
8542 19 74	Gate arrays	7	0.0	1999	WT/Let	0.0	89		
8542 19 76	Standard cells	7	0.0	1999	WT/Let	0.0	89		
8542 19 82	Programmable logic circuits	5.6	0.0	1999	WT/Let	0.0	89		
8542 19 84	Standard logic circuits	5.6	0.0	1999	WT/Let	0.0	89		
	Other				WT/Let	0.0			
8542 19 92	Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let	0.0	89		
8542 19 98	Other	7	0.0	1999	WT/Let	0.0	89		
8542 30	- Other monolithic integrated circuits				WT/Let	0.0			
8542 30 10	Wafers not yet cut into chips	7	0.0	1999	WT/Let	0.0	90		
8542 30 20	Chips	7	0.0	1999	WT/Let	0.0	90		

					<u>Present</u>	Concession first		Attach.	
<u>HS96</u>	Description	Paga rata	Dound rate	Implomentation	concession	incorporated in a	Attach.	A-A-Sect.	
<u> 1390</u>	<u> </u>	<u>Dase rate</u>	<u>Dound rate</u>	Implementation		GATT Schedule Earlier INRs ODC	<u>sect. 1</u>	<u>2</u>	<u>B</u>
	Other				WT/Let	0.0			
8542 30 30	Amplifiers	7	0.0	1999	WT/Let	0.0	90		
8542 30 50	Voltage and current regulators	7	0.0	1999	WT/Let	0.0	90		
	Control circuits				WT/Let	0.0			
8542 30 61	Smartpower circuits	7	0.0	1999	WT/Let	0.0	90		
	Other				WT/Let	0.0			
8542 30 65	Mixed analogue-digital circuits	7	0.0	1999	WT/Let	0.0	90		
8542 30 69	Other	7	0.0	1999	WT/Let	0.0	90		
8542 30 70	Interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let	0.0	90		
	Other				WT/Let	0.0			
8542 30 91	Smartpower circuits	7	0.0	1999	WT/Let	0.0	90		
	Other				WT/Let	0.0			
8542 30 95	Mixed analogue-digital circuits	7	0.0	1999	WT/Let	0.0	90		
8542 30 99	Other				WT/Let	0.0			
8542 40	- Hybrid integrated circuits				WT/Let	0.0			
8542 40 10	Microprocessors, microcontrollers and microcomputers	7	0.0	1999	WT/Let	0.0	91		
8542 40 30	Converters	7	0.0	1999	WT/Let	0.0	91		
8542 40 50	Amplifiers	7	0.0	1999	WT/Let	0.0	91		
8542 40 90	Other	7	0.0	1999	WT/Let	0.0	91		
8542 50 00	- Electronic microassemblies	7	0.0	1999	WT/Let	0.0	92		
8542 90 00	- Parts	4.1	0.0	1999	WT/Let	0.0	93		
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter				WT/Let	0.0			
	- Particle accelerators				WT/Let	0.0			

					Present .	Concession first		Attach.	
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	concession established INR	incorporated in a  GATT Schedule Earlier INRsODC:	Attach. A S Sect. 1	<u>-A-Sect.</u> <u>2</u>	<u>Attach</u> <u>B</u>
8543 89 15	Electrical machines with translation or dictionary functions	5	0.0	2000	WT/Let	0.0	95		
8543 89 17	Apparatus combined with an automatic data processing machine, freely programmable by the user	5	0.0	2000	WT/Let	0.0			191,
8543 89 20	Aerial amplifiers				WT/Let	0.0			
	Sunbeds, sunlamps and similar suntanning equipment				WT/Let	0.0			
	For fluorescent tubes using ultraviolet A rays				WT/Let	0.0			
8543 89 51	With a maximum tube length of 100 cm				WT/Let	0.0			
8543 89 55	Other				WT/Let	0.0			
8543 89 59	Other				WT/Let	0.0			
	Apparatus for physical deposition on semiconductors wafers.				WT/Let	0.0			
8543 89 70	by sputtering on semiconductor wafers	0.0	0.0	1997	WT/Let	0.0		141	
8543 89 72	Other	5	0.0	2000	WT/Let	0.0		147	
8543 89 73	Encapsulation equipment for assembly of semiconductors	5	0.0	2000	WT/Let	0.0		144	
8543 89 79	Multimedia upgrade kits, for automatic data processing machines and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones,and a printed circuit assembly that enables the automatic data processing and units thereof to process audio signals (sound cards)	5	0.0	2000	WT/Let	0.0			202,
8543 89 90	Other				WT/Let	0.0			
8543 90	- Parts				WT/Let	0.0			
8543 90 10	Assemblies and sub-assemblies consisting of two or more parts or pieces fastened or joined together, for flight recorders, for use in civil aircraft				WT/Let	0.0			
8543 90 20	Printed circuit assemblies for physical incorporation into an automatic data processing machine	5	0.0	2000	WT/Let	0.0			199,
8543 90 30	Of apparatus of subheadings 8543 11 00, 8543 30 10, 8543 30 20, 8543 89 70, 8543 89 72 and 8543 89 73	5	0.0	2000	WT/Let	0.0		170,14 9,153,1 69,155, 158	199,
8543 90 90					WT/Let	0.0		.00	

				Present Concession first concession incorporated in a			Attach. Attach. A-A-Sect. Attach			
HS96	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>		GATT Schedule Earlier INRsODC		<u>2</u>	<u>B</u>	
8544	Insulated (including enamelled or anodised) wire, cable (including coaxial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors:				WT/Let	0.0				
	- Other electric conductors, for a voltage not exceeding 80 V				WT/Let	0.0				
8544 41	Fitted with connectors				WT/Let	0.0				
8544 41 10	Of a kind used for telecommunications	4.6	0.0	2000	WT/Let	0.0	96			
8544 41 90	Other				WT/Let	0.0				
8544 49	Other				WT/Let	0.0				
8544 49 20	Of a kind used for telecommunications	4.8	0.0	2000	WT/Let	0.0	97			
8544 49 80	Other				WT/Let	0.0				
	- Other electric conductors, for a voltage exceeding 80 volts but not exceeding 1 000 volts				WT/Let	0.0				
8544 51	Fitted with connectors				WT/Let	0.0				
8544 51 10	Of a kind used for telecommunications	4.6	0.0	2000	WT/Let	0.0	98			
8544 51 90	Other				WT/Let	0.0				
8544 70 00	- Optical fibre cables	6.3	0.0	2000	WT/Let	0.0	99			
8548	Waste and scrap of primary cells, primary batteries and electric accumulators; spent primary cells, spent primary batteries and spent electric accumulators; electrical parts of machinery or apparatus, not specified or included elsewhere in this chapter				WT/Let	0.0				
8548 10	- Waste and scrap of primary cells, primary batteries and electric accumulators; spent primary cells, spent primary batteries and spent electric accumulators				WT/Let	0.0				
8548 10 10	Spent primary cells, spent primary batteries				WT/Let	0.0				
	Spent electric accumulators				WT/Let	0.0				
8548 10 21	Lead-acid accumulators				WT/Let	0.0				
8548 10 29	Other				WT/Let	0.0				
	Waste and scrap of primary cells, primary batteries and electric accumulators				WT/Let	0.0				
8548 10 91	Containing lead				WT/Let	0.0				
8548 10 99	Other				WT/Let	0.0				

					Present concession	Concession first incorporated in a		Attach.	Attach A-A-Sect	<u>.</u> t. Attach
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>e Implementatio</u>	<u>n established INR</u>	GATT Schedule	Earlier INRsODC		2	<u>B</u>
8548 90 0	0 - Other				WT/Let		0.0			
8548 90 10	0 Dynamic random-access memories (D-RAMs) in multi- combinational forms such as 'stack D-RAMs' and modules	3.3	0.0	2000	WT/Let		0.0			199,
8548 90 9	0 Other				WT/Let		0.0			
9006	Photographic (other than cinematographic) cameras; photographic flashlight apparatus and flashbulbs other than discharge lamps of heading No 8539:				WT/Let		0.0			
9006 10	<ul> <li>Cameras of a kind used for preparing printing plates or cylinders</li> </ul>				WT/Let		0.0			
9006 10 10	<ul> <li>O Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates</li> </ul>	0.0	0.0	1997	WT/Let		0.0		181	
9006 10 9	0 Other				WT/Let		0.0			
	- Parts and accessories:				WT/Let		0.0			
9006 91 0	0 For cameras				WT/Let		0.0			
	Other				WT/Let		0.0			
9006 99 10	0 of apparatus of subheading 9006 10 10	4	0.0	2000	WT/Let		0.0		182	
9006 99 9	0 Other				WT/Let		0.0			
9009	Photocopying apparatus incorporating an optical system or of the contact type and thermo- copying apparatus:				WT/Let		0.0			
	<ul> <li>Electrostatic photocopying apparatus</li> </ul>				WT/Let		0.0			
9009 11 0	<ul> <li>Operating by reproducing the original image directly onto the copy (direct process)</li> </ul>	6.5	0.0	2000	WT/Let		0.0	100		
	<ul> <li>Other photocopying apparatus</li> </ul>				WT/Let		0.0			
9009 21 0	0 Incorporating an optical system	6.5	0.0	2000	WT/Let		0.0	101		
9009 90	- Parts and accessories				WT/Let		0.0			
9009 90 10	<ul> <li>Of electrostatic photocopying apparatus or other photocopying apparatus incorporating an optical system</li> </ul>	6.5	0.0	2000	WT/Let		0.0	102		
9009 90 9	0 Other	3.8	0.0	2000	WT/Let		0.0	102		
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection of circuit patterns on sensitived semi-conductor material), not specified or included elsewhere in this chapter, negatoscopes, projection screens				WT/Let		0.0			

		<u>Present</u>		Concession first			Attach.	_
		<u>concessi</u>	<u>sion</u>	incorporated in a		Attach.	<u>A-A-Sect.</u>	Attach
<u>HS96</u>	<u>Description</u>	Base rate Bound rate Implementation establish	<u>hed INR</u>	GATT Schedule	Earlier INRsODCs	<u>Sect. 1</u>	<u>2</u>	<u>B</u>

- Apparatus for the projection or drawing of cir cor.24

					<u>Present</u>	Concession first			Attach.	
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>e Implementation</u>	concession established INR	incorporated in a GATT Schedule	Earlier INRsODCs	Attach. A Sect. 1	<u>-A-Sect</u> <u>2</u>	<u>Attach</u> B
9012 10 10	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	4.5	0.0	2000	WT/Let		0.0		179	
9012 10 90	Other				WT/Let		0.0			
9012 90	- Parts and accessories				WT/Let		0.0			
9012 90 10	Of apparatus of subheading 9012 10 00	4.5	0.0	2000	WT/Let		0.0		180	
9012 90 90	Other				WT/Let		0.0			
9013	Liquid crystal devices not consistuting articles provided for more specifically in other headings; lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this Chapter				WT/Let		0.0			
9013 80	- Other devices, appliances and instruments				WT/Let		0.0			
	Liquid crystal devices:				WT/Let		0.0			
	Active matrix liquid crystal devices				WT/Let		0.0			
9013 80 11	Colour	6.5	0.0	2000	WT/Let		0.0			193,
9013 80 19	Black and white or other monochrome	6.5	0.0	2000	WT/Let		0.0			193,
9013 80 30	Other	6.5	0.0	2000	WT/Let					

<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>e Implementatio</u>	Present concession established INR	Concession first incorporated in a GATT Schedule Earlier INRsODCs	Attach. A-A-Sect. Sect. 1 2	Attach B
9017 20 05	Plotters	3.7	0.0	2000	WT/Let	0.0		198,
9017 20 11	Drawing sets				WT/Let	0.0		
9017 20 19	Other				WT/Let	0.0		
	Marking-out instruments				WT/Let	0.0		
	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated							

					Present concession	Concession first incorporated in a	Atta	ıch. A	Attach.	_ . Attach
HS96	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>		GATT Schedule Earlier INRsOD	Cs Sect	<u>t. 1</u>	2	<u>B</u>
9026 80	- Other instruments or apparatus				WT/Let	0.0	)			
9026 80 10	) For use in civil aircraft	0.0	0.0	1997	WT/Let	0.0	105			
	Other				WT/Let	0.0	)			
9026 80 97	I Electronic	4.8	0.0	2000	WT/Let	0.0	105			
9026 80 99	9 Other	3.6	0.0	2000	WT/Let	0.0	105			
9026 90	- Parts and accessories				WT/Let	0.0	)			
9026 90 10	) For use in civil aircraft	0.0	0.0	1997	WT/Let	0.0	106			
9026 90 90	) Other	3.3	0.0	2000	WT/Let	0.0	106			199,
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes:				WT/Let	0.0	)			
9027 20	<ul> <li>Chromatographs and electrophoresis instruments</li> </ul>				WT/Let	0.0	)			
9027 20 10	) Chromatographs	3.5	0.0	2000	WT/Let	0.0	107			
9027 20 90	) Electrophoresis instruments	4.4	0.0	2000	WT/Let	0.0	107			
9027 30 00	) - Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	3.5	0.0	2000	WT/Let	0.0	) 108			
9027 50 00	O - Other instruments and apparatus using optical radiations (UV, visible, IR)	4.4	0.0	2000	WT/Let	0.0	109			
9027 80	- Other instruments and apparatus				WT/Let	0.0	)			
	Electronic				WT/Let	0.0	)			
9027 80 17	<ul> <li>pH meters, rH meters and other apparatus for measuring conductivity</li> </ul>		0.0	2000	WT/Let	0.0	110			
9027 80 15	5 Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	0.0	0.0	1997	WT/Let	0.0	) 110			
9027 80 18	3 Other	4.4	0.0	2000	WT/Let	0.0	110			
	Other				WT/Let	0.0	)			
9027 80 91	<ul> <li>Viscometers, porosimeters and expansion meters</li> </ul>	4	0.0	2000	WT/Let					

					Present .	Concession first			Attach.	A 1
<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	concession established INR	incorporated in a  GATT Schedule Earlier INRsOL	Att OCs Sed	<u>acn. A-</u> ct. 1		<u>Attach</u> <u>B</u>
9027 80 95	Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	0.0	0.0	1997	WT/Let	0.	0 110	)		
9027 80 98	Other	4	0.0	2000	WT/Let	0.	0 110	)		
9027 90	- Microtomes; parts and accessories				WT/Let	0.	0			
9027 90 10	Microtomes				WT/Let	0.	0			
9027 90 50	Part and accessories of apparatus of subheading 9027 20 to 9027 80	4.4	0.0	2000	WT/Let	0.	0 111	1	,	199,
9027 90 80	Parts and accessories of microtomes or of gas or smoke analysis apparatus				WT/Let	0.	0			
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No 9028; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionizing radiations:				WT/Let	0.	0			
9030 40	- Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)				WT/Let	0.	0			
9030 40 10	For use in civil aircraft	0.0	0.0	1997	WT/Let	0.	0 112	2		
9030 40 90	Other	5.5	0.0	2000	WT/Let	0.	0 112	2		
	- Other instruments and apparatus				WT/Let	0.	0			
9030 82 00	For measuring or checking semiconductor wafers or devices	0.0	0.0	1997	WT/Let	0.	0		184	
9030 90	- Parts and accessories				WT/Let	0.	0			
9030 90 10	For use in civil aircraft				WT/Let	0.	0			
9030 90 20	For apparatus of subheading 9030 82 00	4.4	0.0	2000	WT/Let	0.	0		185,18 <i>°</i> 6	199,
9030 90 80	Other				WT/Let	0.	0			
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this chapter; profile projectors:				WT/Let	0.				
	- Other optical instruments and appliances				WT/Let	0.	0			

<u>HS96</u>	<u>Description</u>	Base rate	Bound rate	<u>Implementation</u>	Present concession established INR	Concession first incorporated in a GATT Schedule		Attach. A Sect. 1	Attach. -A-Sect. 2	<u>Attach</u> <u>B</u>
9031 41 00	O For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	0.0	0.0	1997	WT/Let		0.0		187	
9031 49										